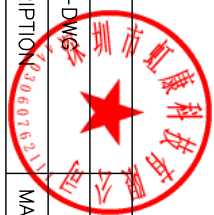


- Note:
- Material:
 - Housing: High temperature thermoplastic with g.f.Ul94V-0
 - Contact: copper alloy, t=0.15mm
 - Shell: copper alloy, t=0.25mm
 - Specification:
 - Current rating: 1.5PIN 1.5A Max/2,3,4PIN 1A Max.
 - Dielectric withstanding voltage: 100 V(ac) for 1 min.
 - Contact resistance: 30 mΩ Max.
 - Insulation resistance: 100 MΩ Min.
 - Total mating force: 3.57 Kgf Max.
 - Total unmating force: 1.0 Kgf Min.
 - Temperature range: -30°C~80°C

11/24-17	DR. BY	ECN. NO.	DESCRIPTION	MARK	VER.
			NEW-DWG		1

TOLERANCES-
UNLESS OTHERWISE SPECIFIED
公差参考表

深圳市虹康科技有限公司
MICRO USB 沉板0.80mm
无卷边



X	±0.25	X.XXX	±0.010	APPD:	PRODUCT NO:	SHK-20045
X.X	±0.20	X.X'	±5.00'	CHECK:	DATE	SCALE
X.XX	±0.15	X.XX'	±2.00'	DRAW:	2017.10.17	1:1
					mm	CD
						1/1